Single D-type flip-flop with set and reset; positive edge trigger Rev. 15 — 22 August 2023

Product data sheet

### 1. General description

The 74LVC2G74 is a single positive edge triggered D-type flip-flop with individual data (D), clock (CP), set ( $\overline{SD}$ ) and reset ( $\overline{RD}$ ) inputs, and complementary Q and  $\overline{Q}$  outputs. Data at the D-input that meets the set-up and hold time requirements on the LOW-to-HIGH clock transition will be stored in the flip-flop and appear at the Q output. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

This device is fully specified for partial power down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

### 2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- Complies with JEDEC standard:
  - JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8-B/JESD36 (2.7 V to 3.6 V)
- $\pm 24$  mA output drive (V<sub>CC</sub> = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

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## 3. Ordering information

 Table 1. Ordering information

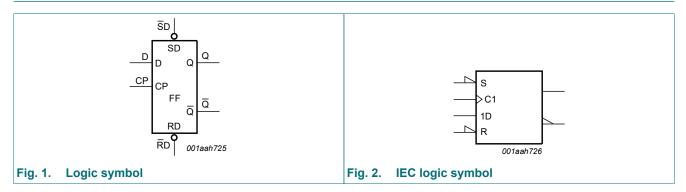
Type number	Package			
	Temperature range	Name	Description	Version
74LVC2G74DP	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	<u>SOT505-2</u>
74LVC2G74DC	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	<u>SOT765-1</u>
74LVC2G74GT	-40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm	<u>SOT833-1</u>
74LVC2G74GN	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.2 × 1.0 × 0.35 mm	<u>SOT1116</u>
74LVC2G74GS	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.0 × 0.35 mm	<u>SOT1203</u>

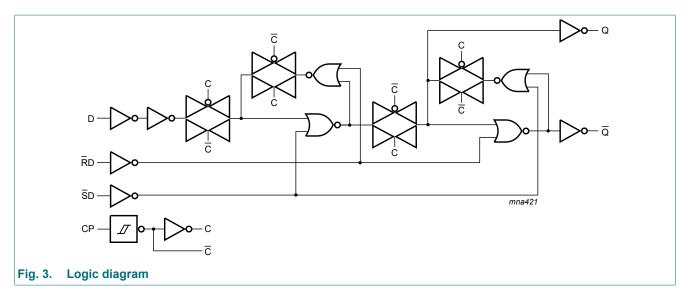
### 4. Marking

Table 2. Marking codes					
Type number	Marking code [1]				
74LVC2G74DP	V74				
74LVC2G74DC	V74				
74LVC2G74GT	V74				
74LVC2G74GN	Y4				
74LVC2G74GS	Y4				

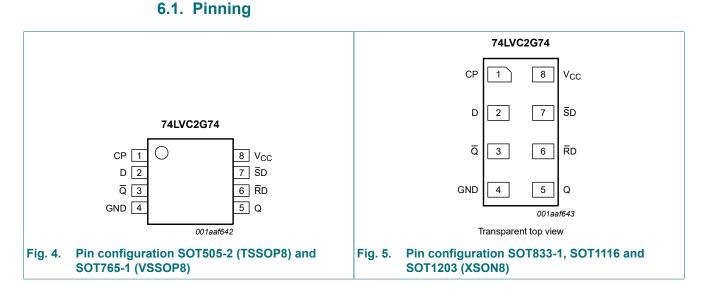
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

# 5. Functional diagram





### 6. Pinning information



### 6.2. Pin description

Table 3. Pin description		
Symbol	Pin	Description
СР	1	clock input (LOW-to-HIGH, edge-triggered)
D	2	data input
Q	3	complement output
GND	4	ground (0 V)
Q	5	true output
RD	6	asynchronous reset-direct input (active LOW)
SD	7	asynchronous set-direct input (active LOW)
V <sub>CC</sub>	8	supply voltage

#### 74LVC2G74

### 7. Functional description

#### Table 4. Function table for asynchronous operation

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H = HIGH voltage level; L = LOW voltage level; X = don't care.
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Input		Output			
SD	RD	СР	D	Q	Q
L	Н	Х	Х	Н	L
Н	L	Х	Х	L	Н
L	L	Х	Х	Н	Н

#### Table 5. Function table for synchronous operation

H = HIGH voltage level; L = LOW voltage level;  $\uparrow = LOW$ -to-HIGH CP transition;  $Q_{n+1} = state$  after the next LOW-to-HIGH CP transition.

Input		Output			
SD	RD	СР	D	Q <sub>n+1</sub>	Q n+1
Н	Н	1	L	L	Н
Н	Н	1	Н	Н	L

### 8. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+6.5	V
l <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+6.5	V
Ι <sub>ΟΚ</sub>	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$		-	±50	mA
Vo	output voltage	Active mode	[1]	-0.5	V <sub>CC</sub> + 0.5	V
		Power-down mode; $V_{CC}$ = 0 V	[1]	-0.5	+6.5	V
lo	output current	$V_{O} = 0 V \text{ to } V_{CC}$		-	±50	mA
I <sub>CC</sub>	supply current			-	100	mA
I <sub>GND</sub>	ground current			-100	-	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[2]	-	250	mW
T <sub>stg</sub>	storage temperature			-65	+150	°C

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT505-2 (TSSOP8) package: P<sub>tot</sub> derates linearly with 4.6 mW/K above 96 °C.

For SOT765-1 (VSSOP8) package: P<sub>tot</sub> derates linearly with 4.9 mW/K above 99 °C.

For SOT833-1 (XSON8) package: P<sub>tot</sub> derates linearly with 3.1 mW/K above 68 °C.

For SOT1116 (XSON8) package: Ptot derates linearly with 4.2 mW/K above 90 °C.

For SOT1203 (XSON8) package: Ptot derates linearly with 3.6 mW/K above 81 °C.

# 9. Recommended operating conditions

Table 7.	Fable 7. Operating conditions								
Symbol	Parameter	Conditions	Min	Max	Unit				
V <sub>CC</sub>	supply voltage		1.65	5.5	V				
VI	input voltage		0	5.5	V				
Vo	output voltage	Active mode	0	V <sub>CC</sub>	V				
		Power-down mode; $V_{CC}$ = 0 V	0	5.5	V				
T <sub>amb</sub>	ambient temperature		-40	+125	°C				
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 1.65 V to 2.7 V	-	20	ns/V				
		V <sub>CC</sub> = 2.7 V to 5.5 V	-	10	ns/V				

### **10. Static characteristics**

### Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	) °C to +85	°C	-40 °C to	Unit	
			Min	Тур <mark>[1]</mark>	Max	Min	Мах	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 1.65 V to 1.95 V	0.65V <sub>CC</sub>	-	-	0.65V <sub>CC</sub>	-	V
	input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	0.7V <sub>CC</sub>	-	-	0.7V <sub>CC</sub>	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.35V <sub>CC</sub>	-	0.35V <sub>CC</sub>	V
	input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.3V <sub>CC</sub>	-	0.3V <sub>CC</sub>	V
V <sub>OH</sub> HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>							
	output voltage	I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.65 V to 5.5 V	V <sub>CC</sub> - 0.1	-	-	V <sub>CC</sub> - 0.1	-	V
		I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V	1.2	1.54	-	0.95	-	V
		I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V	1.9	2.15	-	1.7	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V	2.2	2.50	-	1.9	-	V
		I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V	2.3	2.62	-	2.0	-	V
		I <sub>O</sub> = -32 mA; V <sub>CC</sub> = 4.5 V	3.8	4.11	-	3.4	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>						
	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 5.5 V	-	-	0.10	-	0.10	V
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	0.07	0.45	-	0.70	V
		I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V	-	0.12	0.30	-	0.45	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	0.17	0.40	-	0.60	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	0.33	0.55	-	0.80	V
		I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V	-	0.39	0.55	-	0.80	V

### Single D-type flip-flop with set and reset; positive edge trigger

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to	Unit	
			Min	Typ [1]	Max	Min	Max	
l <sub>l</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	±0.1	±1	-	±1	μA
I <sub>OFF</sub>	power-off leakage current	$V_{1} \text{ or } V_{O} = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$	-	±0.1	±2	-	±2	μA
I <sub>CC</sub>	supply current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 1.65 V to 5.5 V; I <sub>O</sub> = 0 A	-	0.1	4	-	4	μA
ΔI <sub>CC</sub>	additional supply current	per pin; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 2.3 V to 5.5 V	-	5	500	-	500	μA
CI	input capacitance		-	4.0	-	-	-	pF

[1] All typical values are measured at  $T_{amb}$  = 25 °C.

### **11. Dynamic characteristics**

#### Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8.

Symbol	Parameter	Conditions	-4	0 °C to +85	°C	-40 °C to	o +125 °C	Unit
		-	Min	Тур [1]	Max	Min	Max	1
t <sub>pd</sub>	propagation delay	CP to Q, $\overline{Q}$ ; see <u>Fig. 6</u> [2]						
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.5	6.0	13.4	1.5	13.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	3.5	7.1	1.0	7.1	ns
		V <sub>CC</sub> = 2.7 V	1.0	3.5	7.1	1.0	7.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	3.5	5.9	1.0	5.9	ns
		$V_{CC}$ = 4.5 V to 5.5 V	1.0	2.5	4.1	1.0	4.1	ns
		$\overline{SD}$ to Q, $\overline{Q}$ ; see Fig. 7 [2]						
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.5	6.0	12.9	1.5	12.9	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.0	3.5	7.0	1.0	7.0	ns
		V <sub>CC</sub> = 2.7 V	1.0	3.5	7.0	1.0	7.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	3.0	5.9	1.0	5.9	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	1.0	2.5	4.1	1.0	4.1	ns
		$\overline{R}D$ to Q, $\overline{Q}$ ; see Fig. 7 [2]						
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.5	5.0	12.9	1.5	12.9	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.0	3.5	7.0	1.0	7.0	ns
		V <sub>CC</sub> = 2.7 V	1.0	3.5	7.0	1.0	7.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	3.0	5.9	1.0	5.9	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	1.0	2.5	4.1	1.0	4.1	ns

#### Single D-type flip-flop with set and reset; positive edge trigger

Symbol	Parameter	Conditions	-4	0 °C to +85	°C	-40 °C to	o +125 °C	Unit
			Min	Typ [1]	Мах	Min	Max	1
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Fig. 6						
		V <sub>CC</sub> = 1.65 V to 1.95 V	6.2	-	-	6.2	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.7	-	-	2.7	-	ns
		V <sub>CC</sub> = 2.7 V	2.7	-	-	2.7	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.7	1.3	-	2.7	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	2.0	-	ns
		SD and RD LOW; see <u>Fig. 7</u>						
		V <sub>CC</sub> = 1.65 V to 1.95 V	6.2	-	-	6.2	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.7	-	-	2.7	-	ns
		V <sub>CC</sub> = 2.7 V	2.7	-	-	2.7	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.7	1.6	-	2.7	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	2.0	-	ns
t <sub>rec</sub>	recovery time	SD or RD; see <u>Fig. 7</u>						
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.9	-	-	1.9	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.4	-	-	1.4	-	ns
		V <sub>CC</sub> = 2.7 V	1.3	-	-	1.3	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	+1.2	-3.0	-	+1.2	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	1.0	-	-	1.0	-	ns
t <sub>su</sub>	set-up time	D to CP; see <u>Fig. 6</u>						
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.9	-	-	2.9	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	ns
		V <sub>CC</sub> = 2.7 V	1.7	-	-	1.7	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.3	0.5	-	1.3	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	1.1	-	-	1.1	-	ns
t <sub>h</sub>	hold time	D to CP; see <u>Fig. 6</u>						
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.5	-	-	1.5	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	-	-	1.0	-	ns
		V <sub>CC</sub> = 2.7 V	1.0	-	-	1.0	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	0.6	-	1.0	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	1.0	-	-	1.0	-	ns
f <sub>max</sub>	maximum	CP; see <u>Fig. 6</u>						
	frequency	V <sub>CC</sub> = 1.65 V to 1.95 V	80	-	-	80	-	MHz
		V <sub>CC</sub> = 2.3 V to 2.7 V	175	-	-	175	-	MHz
		V <sub>CC</sub> = 2.7 V	175	-	-	175	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V	175	280	-	175	-	MHz
		V <sub>CC</sub> = 4.5 V to 5.5 V	200	-	-	200	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$V_{I} = GND$ to $V_{CC}$ ; $V_{CC} = 3.3 V$ [3]	-	15	-	-	-	pF

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

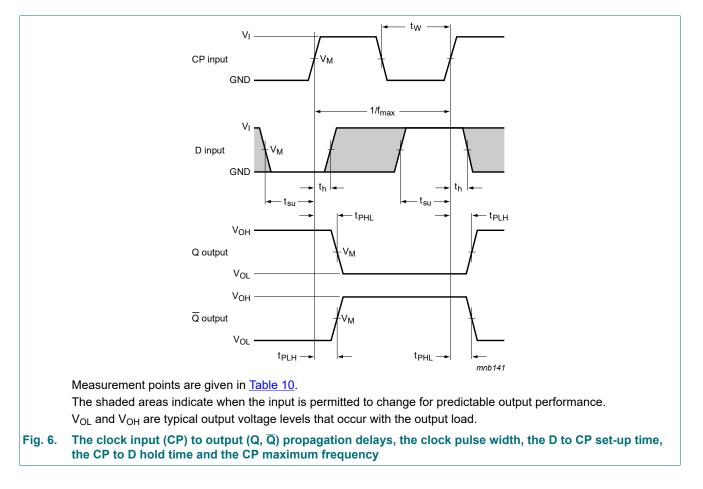
[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).  $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz;

 $C_L$  = output load capacitance in pF;  $V_{CC}$  = supply voltage in V; N = number of inputs switching;  $\sum (C_L \times V_{CC}^2 \times f_0)$  = sum of outputs.

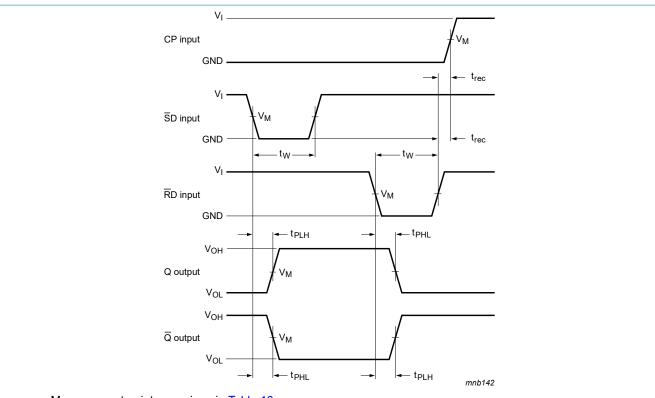
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### 11.1. Waveforms and test circuit

### Single D-type flip-flop with set and reset; positive edge trigger



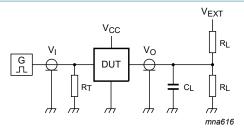
Measurement points are given in <u>Table 10</u>.

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical output voltage levels that occur with the output load.

# Fig. 7. The set (SD) and reset (RD) input to output (Q, Q) propagation delays, the set and reset pulse widths and the RD to CP recovery time

#### Table 10. Measurement points

Supply voltage	Input	Output	
V <sub>cc</sub>	V <sub>M</sub>	V <sub>M</sub>	
1.65 V to 1.95 V	$0.5 \times V_{CC}$	0.5 × V <sub>CC</sub>	
2.3 V to 2.7 V	0.5 × V <sub>CC</sub>	0.5 × V <sub>CC</sub>	
2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	1.5 V	1.5 V	
4.5 V to 5.5 V	$0.5 \times V_{CC}$	0.5 × V <sub>CC</sub>	



Test data is given in Table 11.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

 $C_{\text{L}}$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

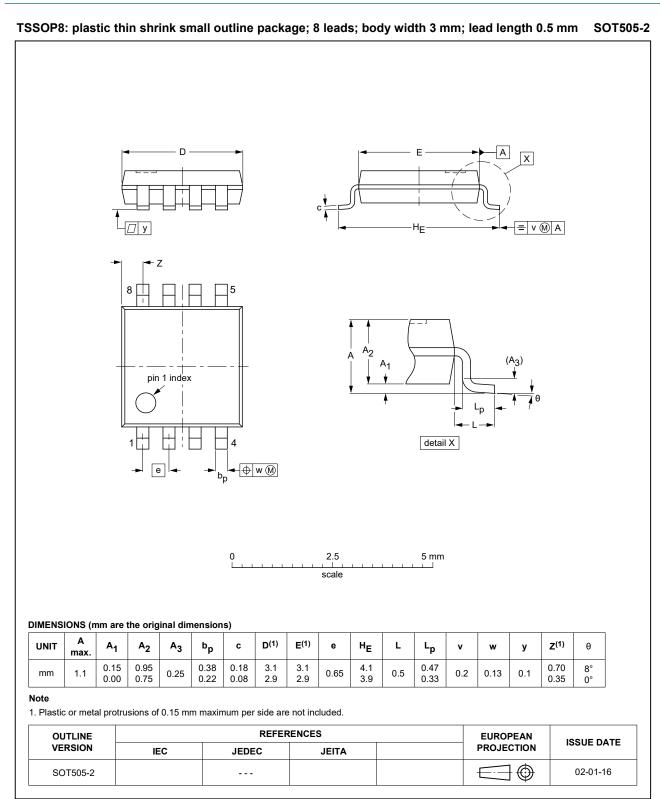
 $V_{EXT}$  = External voltage for measuring switching times.

#### Fig. 8. Test circuit for measuring switching times

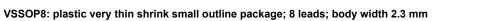
#### Table 11. Test data

Supply voltage Input		Load	Load		V <sub>EXT</sub>		
V <sub>cc</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
1.65 V to 1.95 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	1 kΩ	open	GND	2V <sub>CC</sub>
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	500 Ω	open	GND	2V <sub>CC</sub>
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	GND	6 V
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	GND	6 V
4.5 V to 5.5 V	V <sub>CC</sub>	≤ 2.5 ns	50 pF	500 Ω	open	GND	2V <sub>CC</sub>

### 12. Package outline



#### Fig. 9. Package outline SOT505-2 (TSSOP8)





/SSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm				
$ \begin{array}{c} & & & \\ & & & & \\ & & & & \\ & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ $				
0 5 mm				
Dimensions (mm are the original dimensions)				
scale				
$\frac{\text{Dimensions (mm are the original dimensions)}}{\text{Scale}}$ $\frac{\text{Dimensions (mm are the original dimensions)}}{\frac{\text{Unit}}{\text{max.}} \begin{array}{c} A_{1} \\ A_{2} \\ A_{3} \\ A_{1} \\ A_{2} \\ A_{3} \\ A_{3} \\ B_{p} \\ C \\ D^{(1)} \\ E^{(2)} \\ e \\ H_{E} \\ L \\ A_{p} \\ A_{p} \\ A_{p} \\ A_{p} \\ A_{1} \\ A_{p} \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{p} \\ C \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{p} \\ C \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{p} \\ C \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{p} \\ C \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{p} \\ C \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{p} \\ C \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{p} \\ C \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{1} \\ A_{2} \\ A_{3} \\ B_{1} \\ A_{2} \\ A_{3} \\ B_{1} \\ B_{2} \\ C \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{1} \\ B_{2} \\ C \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{1} \\ B_{2} \\ C \\ A_{1} \\ A_{2} \\ A_{3} \\ B_{1} \\ B_{1} \\ C \\ A_{1} \\ C \\ A_{1} \\ C \\ A_{2} \\ C \\ A_{1} \\ C \\ $	sot765 1 cc			
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$\begin{array}{c c c c c c c c c c c c c c c c c c c $	<u>sot765-1_po</u> ue date <del>2-06-02-</del>			

Fig. 10. Package outline SOT765-1 (VSSOP8)

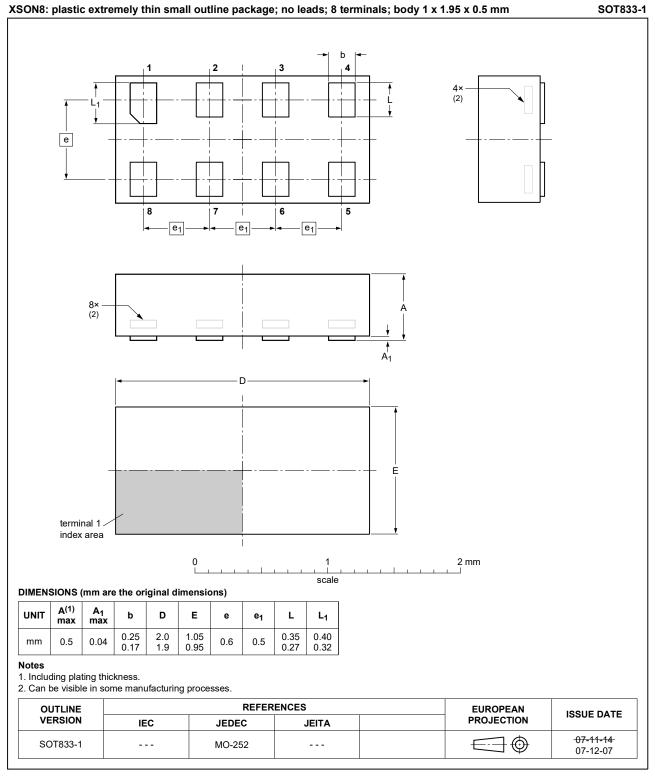
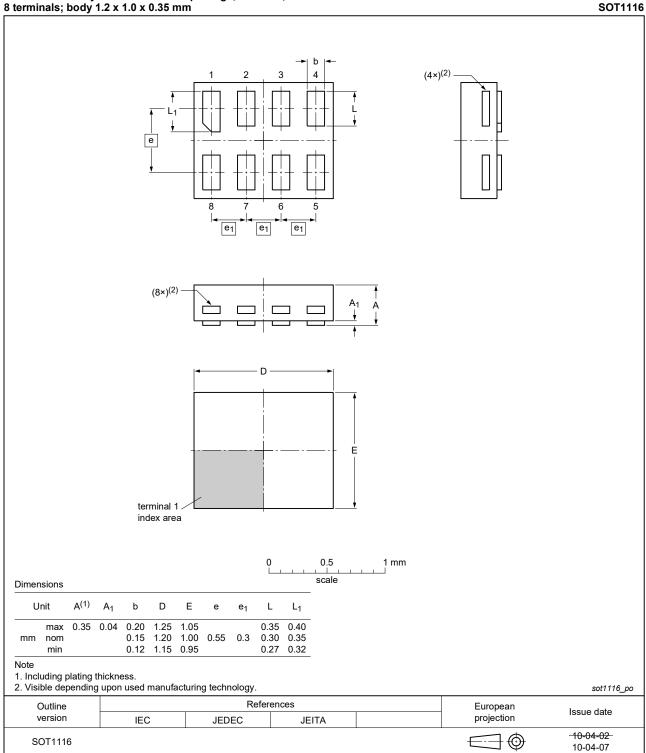


Fig. 11. Package outline SOT833-1 (XSON8)

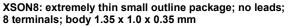
#### XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.2 x 1.0 x 0.35 mm

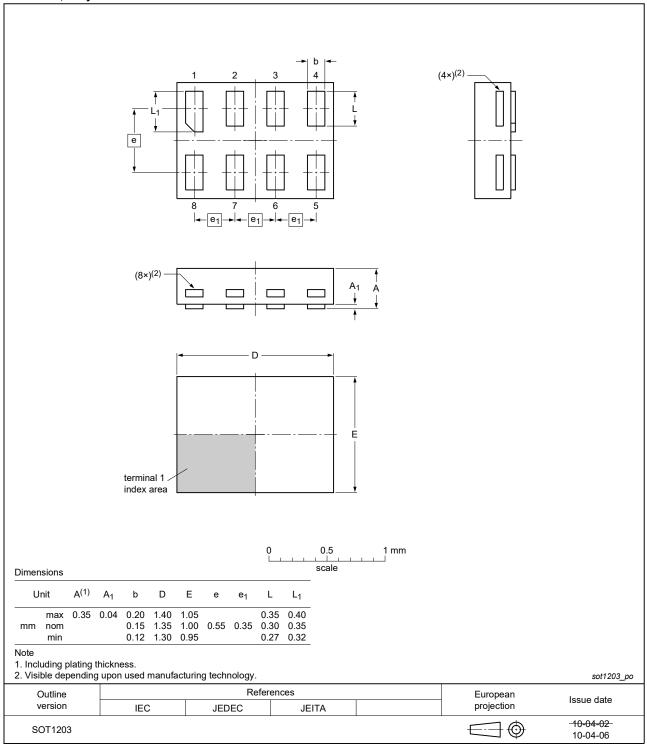




SOT1203

#### Single D-type flip-flop with set and reset; positive edge trigger







# 13. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

### 14. Revision history

Table	13.	Revision	history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC2G74 v.15	20230822	Product data sheet	-	74LVC2G74 v.14		
Modifications:	• <u>Section 2</u> : E	<u>Section 2</u> : ESD specification updated according to the latest JEDEC standard.				
74LVC2G74 v.14	20210827	Product data sheet	-	74LVC2G74 v.13		
Modifications:	Type number	Type number 74LVC2G74GM (SOT902-2/XQFN8) removed.				
74LVC2G74 v.13	20210421	Product data sheet	-	74LVC2G74 v.12		
Modifications:	• <u>Section 1</u> ar					
74LVC2G74 v.12	20181003	Product data sheet	-	74LVC2G74 v.11		
Modifications:	of Nexperia. • Legal texts I		new company name	nply with the identity guidelines e where appropriate.		
74LVC2G74 v.11	20161215	Product data sheet	-	74LVC2G74 v.10		
Modifications:	• <u>Table 8</u> : The	maximum limits for leaka	age current and sup	ply current have changed.		
74LVC2G74 v.10	20130402	Product data sheet	-	74LVC2G74 v.9		
Modifications:	For type nur	For type number 74LVC2G74GD XSON8U has changed to XSON8.				
74LVC2G74 v.9	20120522	Product data sheet	-	74LVC2G74 v.8		
Modifications:	For type nur	For type number 74LVC2G74GM the sot code has changed to SOT902-2.				
74LVC2G74 v.8	20111128	Product data sheet	-	74LVC2G74 v.7		
Modifications:	<ul> <li>Legal pages</li> </ul>	Legal pages updated.				
74LVC2G74 v.7	20101011	Product data sheet	-	74LVC2G74 v.6		
74LVC2G74 v.6	20091223	Product data sheet	-	74LVC2G74 v.5		
74LVC2G74 v.5	20080630	Product data sheet	-	74LVC2G74 v.4		
74LVC2G74 v.4	20080207	Product data sheet	-	74LVC2G74 v.3		
74LVC2G74 v.3	20070809	Product data sheet	-	74LVC2G74 v.2		
74LVC2G74 v.2	20061214	Product data sheet	-	74LVC2G74 v.1		

74LVC2G74

# 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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